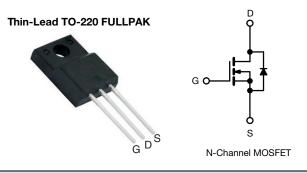
SiHA6N80E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.82			
Q _g max. (nC)	44				
Q _{gs} (nC)	5				
Q _{gd} (nC)	8				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA6N80E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25$ °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C) e	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	5.4	
	V _{GS} at 10 V	T _C = 100 °C		3.4	А
Pulsed drain current ^a			I _{DM}	15	
Linear derating factor				0.25	W/°C
Single pulse avalanche energy ^b			E _{AS}	95	mJ
Maximum power dissipation			PD	31	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		70	N//	
Reverse diode dv/dt ^d			dv/dt	0.25	V/ns
Soldering recommendations (peak temperature) ^c	For 10 s			300	°C
Mounting torque	M3 screw			0.6	Nm

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.6 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 65 - 4.0			20.04			
Maximum junction-to-case (drain)	R _{thJC}				°C/W			
SPECIFICATIONS (T _J = 25 °C, u	unless otherw	ise noted)						
PARAMETER	SYMBOL	-	T CONDITION	۹	MIN.	TYP.	MAX.	UNI
Static	OTMODE	120		<u> </u>	IVIII .		MAX.	UNI
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250	AL	800	- 1	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I _D =		-	1.1	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 250		2.0	-	4.0	V
	- 63(11)		$V_{GS} = \pm 20 V$	P	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
			= 800 V, V _{GS} =	0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	-	/, V _{GS} = 0 V, T _J		-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =		-	0.82	0.94	Ω
Forward transconductance	9 _{fs}	V _{DS}	$s = 30 \text{ V}, \text{ I}_{\text{D}} = 3$	A	-	2.5	-	S
Dynamic						I	1	
Input capacitance	C _{iss}		V_{GS} = 0 V, V_{DS} = 100 V,		-	827	-	-
Output capacitance	C _{oss}				-	37	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	24	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	109	-	1	
Total gate charge	Qg				-	22	44	1
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 480 \text{ V}$		-	5	-	nC	
Gate-drain charge	Q _{gd}				-	8	-	1
Turn-on delay time	t _{d(on)}				-	13	26	
Rise time	t _r	Vpp	= 480 V, I _D = 3	Δ	-	9	18	
Turn-off delay time	t _{d(off)}		= 10 V, R _q = 9. ⁻		-	27	54	ns
Fall time	t _f				-	18	36	1
Gate input resistance	R _g	f = 1 MHz, open drain		0.5	1.0	2.0	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5.4		
Pulsed diode forward current	I _{SM}			-	-	15	A	
Diode forward voltage	V _{SD}	T.I = 25 °	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	-	1.2	v
Reverse recovery time	t _{rr}			-	-	282	564	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	2.0	4.0	μΟ	
Reverse recovery current	I _{RRM}			_	11	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

2

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SiHA6N80E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

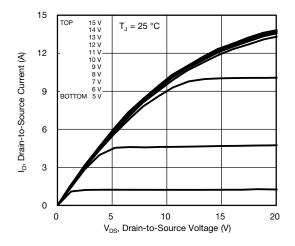
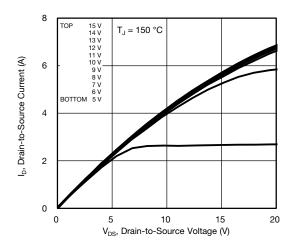


Fig. 1 - Typical Output Characteristics





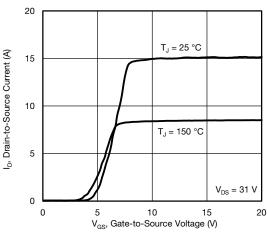
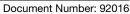


Fig. 3 - Typical Transfer Characteristics

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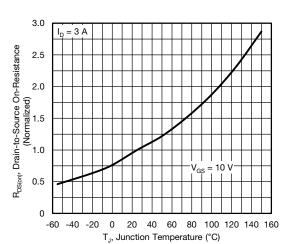


Fig. 4 - Normalized On-Resistance vs. Temperature

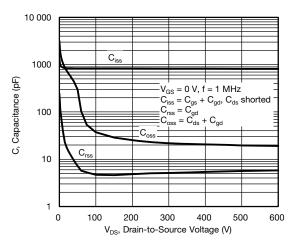
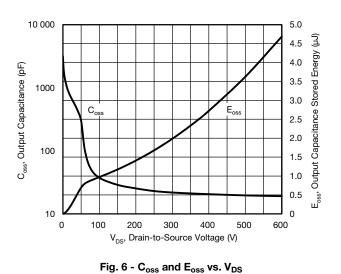


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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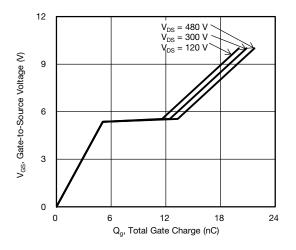


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

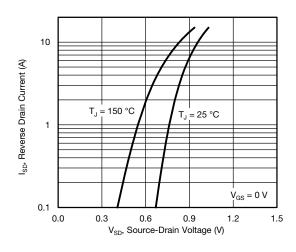


Fig. 8 - Typical Source-Drain Diode Forward Voltage

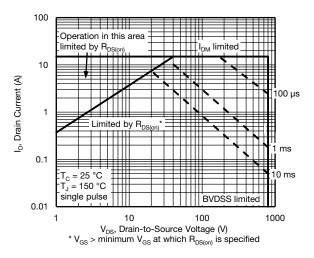


Fig. 9 - Maximum Safe Operating Area

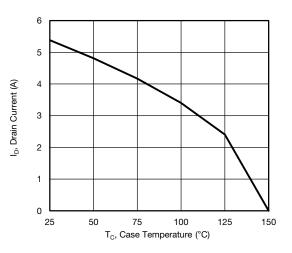


Fig. 10 - Maximum Drain Current vs. Case Temperature

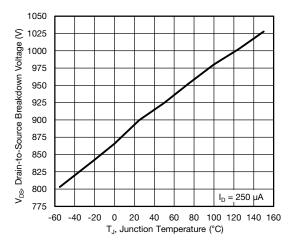


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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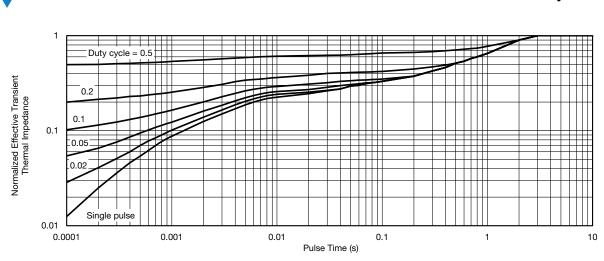
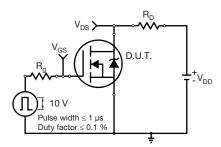


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

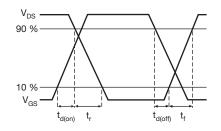


Fig. 14 - Switching Time Waveforms

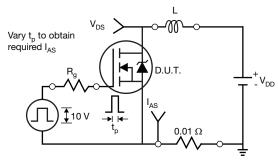


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

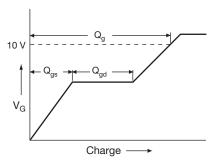


Fig. 17 - Basic Gate Charge Waveform

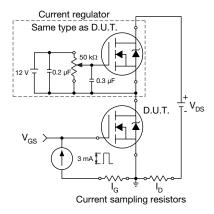


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

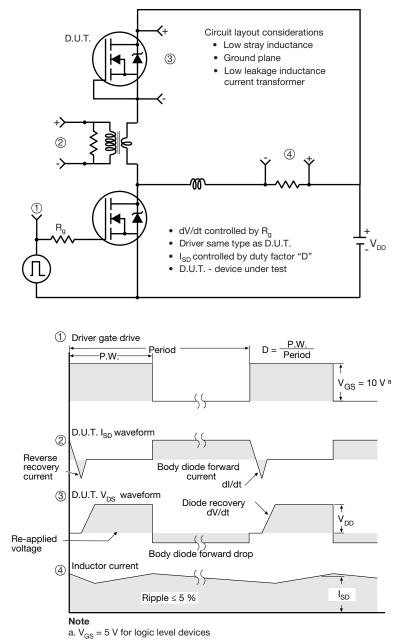


Fig. 19 - For N-Channel

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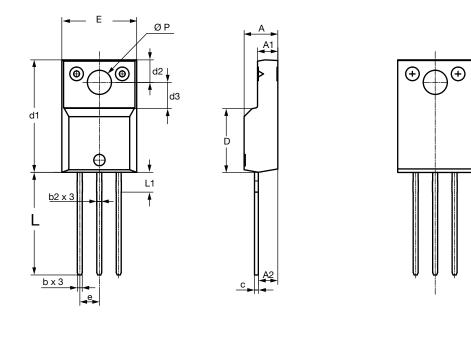
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS		
SYMBOL	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	-	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
E	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØP	3.00	3.40	0.118	0.134	
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·		

Revision: 28-Dec-2020

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